

Dual N-Channel Enhancement Mode MOSFET

General Description

The CMS4892 uses advanced
Technology, which provides low
on-state resistance, high switching
performance and excellent
reliability.

Features

- RDS(ON)<120mΩ @ VGS=10V
- RDS(ON)<200mΩ @ VGS=4.5V
- Dual MOSFET in surface mount package.
- Extremely low on-resistance RDS(on)

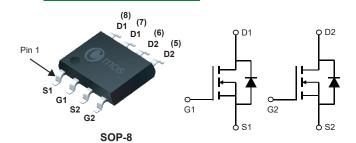
Product Summary

BVDSS	RDSON	ID
100V	120mΩ	5A

Applications

- Motor control and drive
- Battery management
- UPS (Uninterrupible Power Supplies)

SOP-8 Pin Configuration



Туре	Package	Marking		
CMS4892	SOP-8	CMS4892		

Absolute Maximum Ratings

Symbol	nbol Parameter I		Units	
V _{DS}	Drain-Source Voltage 100		V	
V_{GS}	Gate-Source Voltage	±20	V	
I _D	Continuous Drain Current	5	А	
I _{DM}	Pulsed Drain Current	15	А	
P _D @T _C =25℃	Total Power Dissipation	2	W	
T _{STG}	Storage Temperature Range	-55 to 150	$^{\circ}$	
T _J	Operating Junction Temperature Range	-55 to 150	$^{\circ}$	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{θJA}	Thermal Resistance, Junction-to-Ambient (PCB mounted)		62.5	℃/W



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Electrical Characteristics (T_J=25[°]C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0 V , I_D =250 μ A	100			V
D	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =5A			120	mΩ
R _{DS(ON)}	Static Drain-Source On-Nesistance	V _{GS} =4.5V , I _D =3A			150	11177
VGS(th)	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	1		3	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V,V _{GS} =0V			1	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =10V, I _D =3A		4.5		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		8		Ω
Q_g	Total Gate Charge			6.5		
Q_{gs}	Gate-Source Charge	V _{DS} =50V , V _{GS} =10V , I _D =5A		1.5		nC
Q_{gd}	Gate-Drain Charge			1.5		
$T_{d(on)}$	Turn-On Delay Time			5		
T _r	Rise Time	V_{DS} =50V , R_{GEN} =3 Ω , V_{GS} =10V		2		ns
$T_{d(off)}$	Turn-Off Delay Time	R _L =12.5Ω		15		115
T _f	Fall Time			2		
C _{iss}	Input Capacitance			370		
C _{oss}	Output Capacitance	V _{DS} =50V , V _{GS} =0V , f=1MHz		33		pF
C _{rss}	Reverse Transfer Capacitance			3		

Diode Characteristics

L	Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
	Is	Continuous Source Current	-V _G =V _D =0V , Force Current			5	Α
I	I _{SM}	Pulsed Source Current				15	Α
	V_{SD}	Diode Forward Voltage	V_{GS} =0V , I_{S} =4A , T_{J} =25 $^{\circ}$ C			1	V

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